

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T _j (°C)	VALUE			UNIT	
				Min	Type	Max		
I _{T(AV)}	Mean on-state current	180° half sine wave 50Hz single side cooled, T _{hs} =55°C	125			168	A	
I _{T(AV)}	Mean on-state current	180° half sine wave 50Hz single side cooled, T _{hs} =80°C	125			100	A	
V _{DRM} V _{RRM}	Repetitive peak off-state voltage Repetitive peak reverse voltage	V _{DRM} &V _{RRM} tp=10ms V _{Dsm} &V _{Rsm} = V _{DRM} &V _{RRM} +100V respectively	125	100		2000	V	
I _{DRM} I _{RRM}	Repetitive peak current	at V _{DRM} at V _{RRM}	125			30	mA	
I _{TSM}	Surge on-state current	10ms half sine wave	125			1.9	KA	
I ² T	I ² T for fusing coordination	V _R =0.6V _{RRM}					18	A ² s*10 ³
V _{TO}	Threshold voltage		125			1.36	V	
r _T	On-state slop resistance						1.28	mΩ
V _{TM}	Peak on-state voltage	I _{TM} =300A	125			2.0	V	
dv/dt	Critical rate of rise of off-state voltage	V _{DM} =0.67V _{DRM}	125			500	V/μs	
di/dt	Critical rate of rise of on-state current	From 67%V _{DRM} to 1000A, Gate source 1.5A t _r ≤0.5μs Repetitive	125			100	A/μs	
I _{rm}	Reverse recovery current	I _{TM} =500A, tp=1000μs, di/dt=-20A/μs, V _i =50V	125			90	A	
t _{rr}	Reverse recovery time						8	μs
Q _{rr}	Recovery charge						360	μC
I _{GT}	Gate trigger current	V _A =12V, I _A =1A	25	10		200	mA	
V _{GT}	Gate trigger voltage			0.8		2.7	V	
I _H	Holding current			10		200	mA	
V _{GD}	Non-trigger gate voltage	At 67%V _{DRM}	125			0.3	V	
R _{th(j-h)}	Thermal resistance Junction to heatsink	At 180° sine' single side cooled Clamping torque 17 N·m				0.200	°C /W	
F _m	Mounting torque			13		19	N·m	
T _{stg}	Stored temperature			-40		140	°C	
Outline	T2							

Outline

